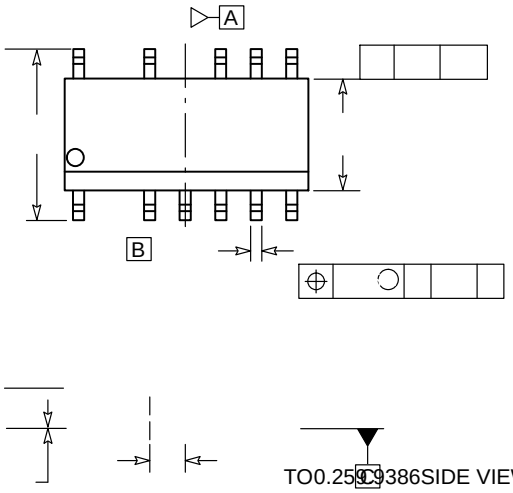
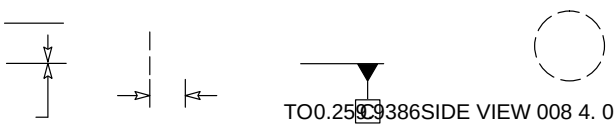
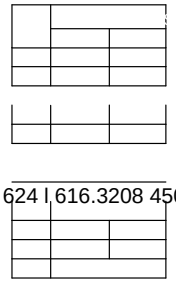
SOIC ï14
CASE 751AP
ISSUE B

DATE 18 MAY 2015

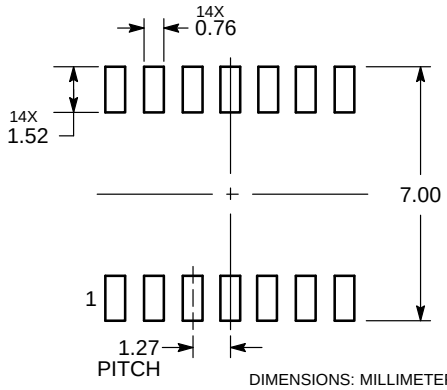






TO0.25 C9386SIDE VIEW 008 4. 0 m 0 [] 5 -1e f 153.184 624 l 616.3208 450.765 90 105563 5483 cm0 105563 5483 cm0

RECOMMENDED
SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb ïFree strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.